650V N-Channel MOSFET

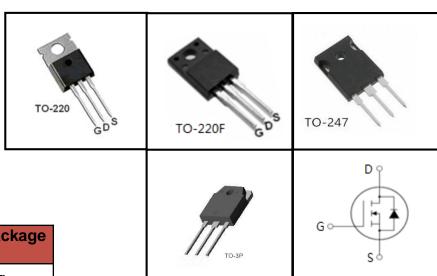
FEATURES

- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)

Device M Information			Package
Device	Package		Marking
CS20N65F	TO-220F		CS20N65F
CS20N65W	TO-247		CS20N65W
CS20N65V	TO-3P		CS20N65V
CS20N65P	TO-220	·	CS20N65P



Absolute Maximum Ratings $T_C = 25^{\circ}C$, unless otherwise noted						
Barranatar	Symbol		11			
Parameter		TO-220F	TO-220	TO-247	TO-3P	Unit
Drain-Source Voltage (V _{GS} = 0V)	V _{DSS}		6	50		V
Continuous Drain Current	I _D	20			А	
Pulsed Drain Current (note1)	I _{DM}	80			А	
Gate-Source Voltage	V_{GSS}	±30		V		
Single Pulse Avalanche Energy (note2)	E _{AS}	605		mJ		
Avalanche Current (note1)	I _{AS}	11		А		
Repetitive Avalanche Energy (note1)	E _{AR}	363		mJ		
Power Dissipation (T _C = 25°C)	P _D	120			W	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55~+150				°C

Thermal Resistance							
Parameter	Symbol		Va	lue		Unit	
Parameter	Symbol	TO-220F	TO-220	TO-247	TO-3P	Unit	
Thermal Resistance, Junction-to-Case	R_{thJC}	1.04		°C/W			
Thermal Resistance, Junction-to-Ambient	R_{thJA}	62.5 50		0	°C/VV		

	Symbol Test Conditions		Value			
Parameter			Min.	Min. Typ. Max.		Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	650			V
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	μΑ
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3.0		4.0	V
Drain-Source On-Resistance (Note3)	R _{DS(on)}	$V_{GS} = 10V, I_{D} = 10A$		0.35	0.4	Ω
Dynamic						
Input Capacitance	C _{iss}	V 0V		2701		
Output Capacitance	C _{oss}	$V_{GS} = 0V,$ $V_{DS} = 25V,$		249.5		pF
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		24.8		
Total Gate Charge	Q_g			80		
Gate-Source Charge	Q_gs	$V_{DD} = 520V, I_{D} = 20A,$ $V_{GS} = 10V$		12		nC
Gate-Drain Charge	Q_{gd}	GS 101		34		
Turn-on Delay Time	t _{d(on)}			54		
Turn-on Rise Time	t _r	$V_{DD} = 325V, I_{D} = 20A,$		48.4		
Turn-off Delay Time	t _{d(off)}	$R_G = 25 \Omega$		301		ns
Turn-off Fall Time	t _f			85		1
Drain-Source Body Diode Character	istics					
Continuous Body Diode Current	Is	T 0500			20	
Pulsed Diode Forward Current	I _{SM}	T _C = 25 °C			80	А
Body Diode Voltage	V_{SD}	$T_J = 25^{\circ}C$, $I_{SD} = 10A$, $V_{GS} = 0V$			1.4	V
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V, I_{S} = 20A,$		741		ns
Reverse Recovery Charge	Q _{rr}	$di_{F}/dt = 100A / \mu s$		4.71		μC

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. L=10mH, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25 $^{\circ}C$
- 3. Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 1. Output Characteristics ($T_J = 25^{\circ}C$)

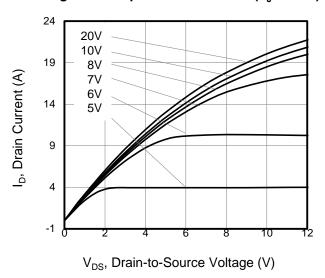


Figure 3. Drain Current vs. Temperature

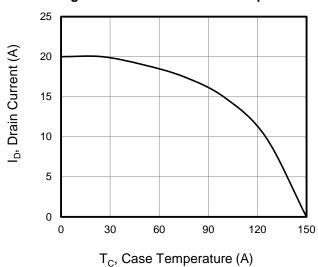


Figure 5. Transfer Characteristics

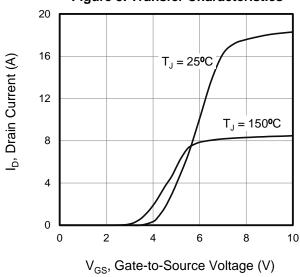


Figure 2. Body Diode Forward Voltage

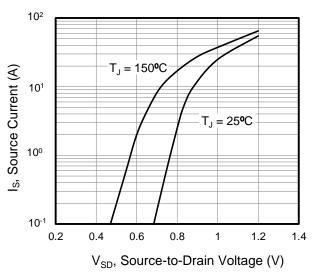
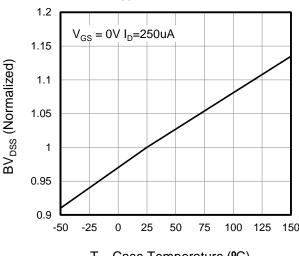
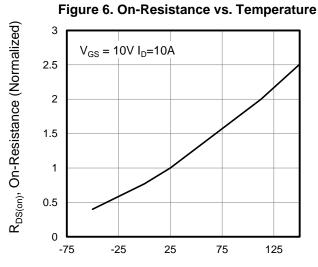


Figure 4. BV_{DSS} Variation vs. Temperature



T_C, Case Temperature (°C)



T_J, Junction Temperature (°C)

Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

Figure 7. Capacitance

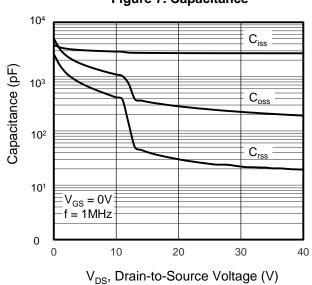
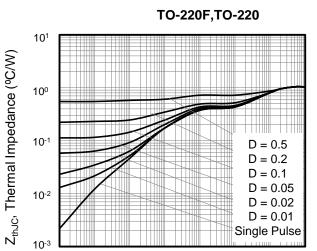


Figure 9. Transient Thermal Impedance



10-3

10-2

T_p, Pulse Width (s)

10-1

10⁰

10¹

Figure 8. Gate Charge

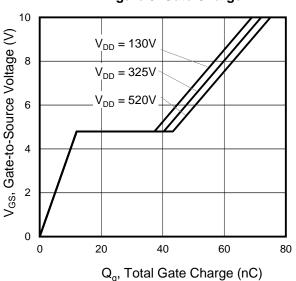
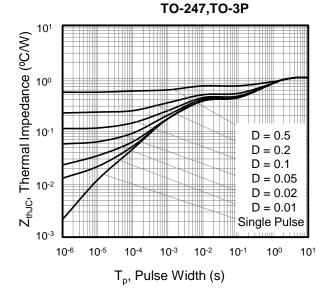


Figure 10. Transient Thermal Impedance



10-6

10-5

10-4

Figure A: Gate Charge Test Circuit and Waveform

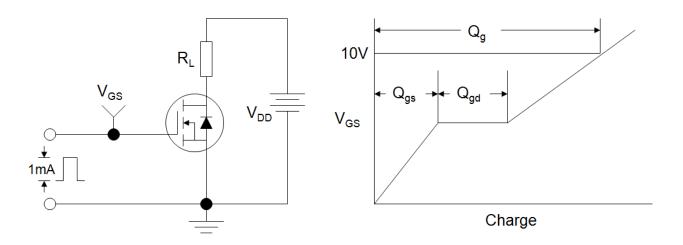


Figure B: Resistive Switching Test Circuit and Waveform

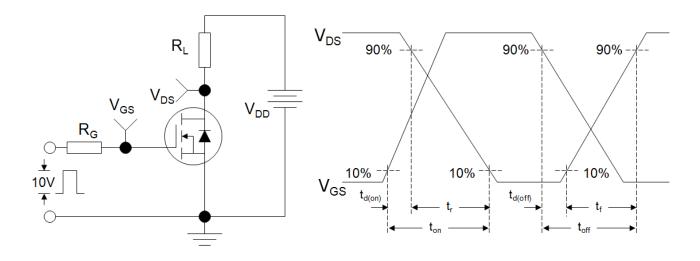
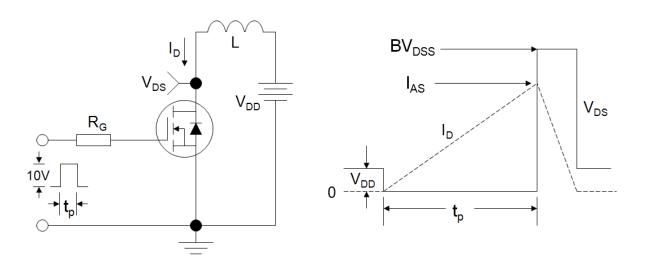
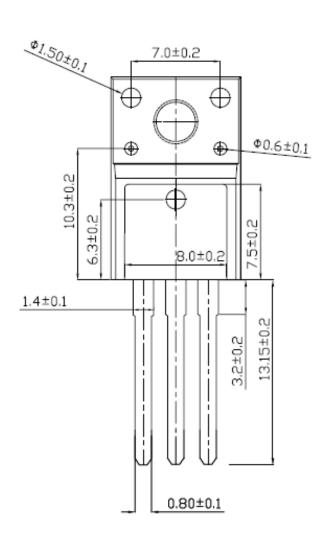
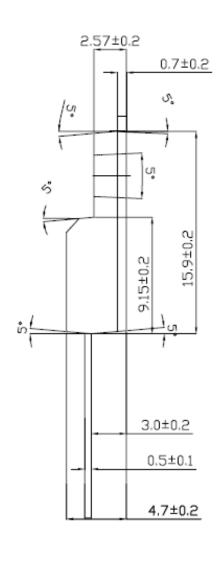


Figure C: Unclamped Inductive Switching Test Circuit and Waveform

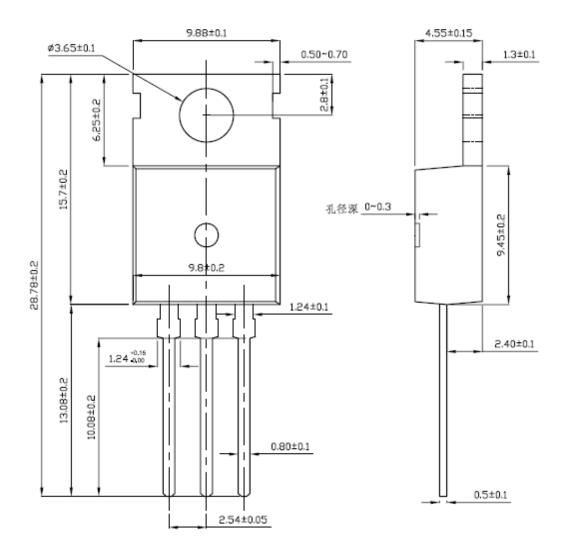


TO-220F

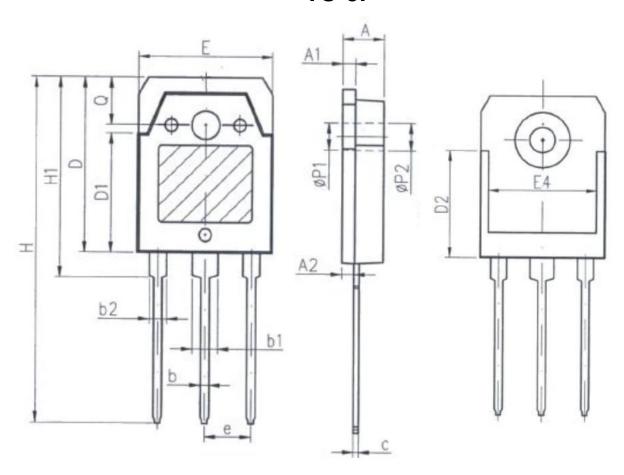




TO-220

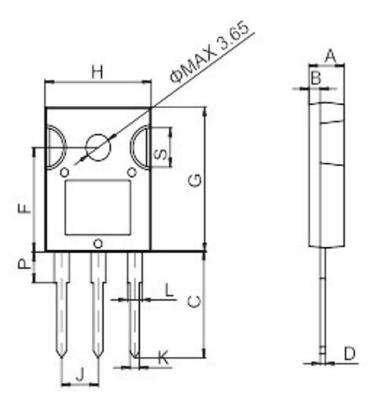


TO-3P



Unit:mm						
Symbol	Min.	Max.				
Α	4. 6	5				
A1	1. 4	1. 65				
A2	1. 18	1. 58				
b	0.8	1. 2				
b1	2. 8	3. 2				
b2	1. 8	2. 2				
С	0. 5	0. 75				
D	19. 6	20. 2				
D1	13. 55	14. 25				
D2	12. 9	PREF				
E	15. 35	15. 85				
E4	12. 6	_				
е	5. 45TYP					
Н	40. 1	40. 9				
H1	23. 15	23. 65				
P1	3. 2REF					
P2	3. 5REF					

TO-247



Ref.		Dimensions							
	1	MIIImeters			Inches				
	Min.	Тур.	Max.	Min.	Тур.	Max.			
Α	4.9		5.4	0.193		0.213			
В	1.6		2.0	0.063		0.079			
С	14.35		15.4	0.565		0.606			
D	0.5		0.8	0.020		0.031			
F	14.4		15.1	0.567		0.594			
G	19.7		20.6	0.775		0.811			
Н	15.4		16.2	0.606		0.638			
J	5.3		5.6	0.209		0.220			
K	1.3		1.5	0.051		0.059			
L	2.8		3.3	0.110		0.130			
Р	3.7		4.2	0.146		0.165			
S	5.35		5.65	0.211		0.222			



Disclaimer

All product specifications and data are subject to change without notice.

For documents and material available from this datasheet, Suzhou Convert does not warrant or assume any legal liability or responsibility for the accuracy, completeness of any product or technology disclosed hereunder.

No license, express or implied, by estoppels or otherwise, to any intellectual property rights is granted by this document or by any conduct of Suzhou Convert.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless. Customers using or selling Suzhou Convert products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Suzhou Convert for any damages arising or resulting from such use or sale.

Suzhou Convert disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Suzhou Convert's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

Suzhou Convert SemiConductor CO., Ltd. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.

In the event that any or all Suzhou Convert products (including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.

Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. Suzhou Convert believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.